

PLEASE CHECK WWW.MOLEX.COM FOR LATEST PART INFORMATION

Part Number: [0443800007](#)
Status: **Active**
Overview: [modular_plugs_jacks](#)
Description: Modular Jack, Right Angle, Low Profile, Inverted, 8/8, Unshielded

Documents:
[3D Model](#) [Product Specification PS-43860-003 \(PDF\)](#)
[Drawing \(PDF\)](#) [RoHS Certificate of Compliance \(PDF\)](#)
[Application Specification \(PDF\)](#)

Agency Certification

CSA LR19980
UL E107635

General

Product Family Modular Jacks/Plugs
Series [44380](#)
Component Type PCB Jack
Magnetic No
Overview [modular_plugs_jacks](#)
Performance Category 3
Power over Ethernet (PoE) N/A
Product Name RJ45

Physical

Boot Color N/A
Color - Resin Black, Clear
Durability (mating cycles max) 500
Inverted / Top Latch Yes
Keying to Mating Part None
Lightpipes/LEDs Lightpipes
Material - Metal Phosphor Bronze
Material - Plating Mating Gold
Material - Plating Termination Tin
Material - Resin High Temperature Thermoplastic, Polycarbonate
Orientation Right Angle (Side Entry)
PCB Locator Yes
PCB Retention Yes
PCB Thickness Recommended (in) 0.039 In
PCB Thickness Recommended (mm) 1.00 mm
Packaging Type Tube
Panel Mount Without Flange
Pitch - Mating Interface (in) 0.040 In
Pitch - Mating Interface (mm) 1.02 mm
Pitch - Term. Interface (in) 0.040 In
Pitch - Term. Interface (mm) 1.02 mm
Plating min: Mating (µin) 50
Plating min: Mating (µm) 1.25
Plating min: Termination (µin) 100
Plating min: Termination (µm) 2.5
Ports 1
Positions / Loaded Contacts 8/8
Surface Mount Compatible (SMC) Yes
Temperature Range - Operating -40°C to +85°C
Termination Interface: Style Through Hole
Waterproof / Dustproof No

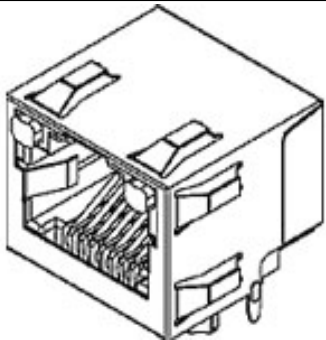


image - Reference only

Series

EU RoHS
ELV and RoHS
Compliant
REACH SVHC
Not Reviewed
Halogen-Free
Status
Not Reviewed

China RoHS



Need more information on product environmental compliance?

Email productcompliance@molex.com
For a multiple part number RoHS Certificate of Compliance, [click here](#)

Please visit the [Contact Us](#) section for any non-product compliance questions.

Search Parts in this Series
[44380Series](#)

Mates With
FCC 68 Plugs

Wire/Cable Type	N/A
Electrical	
Current - Maximum per Contact	1.5A
Grounding to PCB	No
Grounding to Panel	None
Shielded	No
Voltage - Maximum	150V AC (RMS)
Solder Process Data	
Lead-free Process Capability	Wave Capable (TH only)
Material Info	
Reference - Drawing Numbers	
Application Specification	AS-43860-001
Packaging Specification	PK-43860-004
Product Specification	PS-43860-003, RPS-43860-004, RPS-43860-007, RPS-43860-008, RPS-43860-013
Sales Drawing	SD-44380-001

This document was generated on 06/08/2010

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NOTES

1) MATERIAL:

HOUSING: GLASS FILLED NYLON, 94V-0 COLOR: BLACK
TERMINALS: PHOSPHOR BRONZE, .015/(0.38) THICK
SHIELD: BRASS

2) PLATING:

TERMINALS:

SELECT GOLD IN CONTACT AREA: 50 MICROINCHES (1.27 MICROMETERS) MIN.,
*SELECT TIN IN PC TAIL AREA: 100 MICROINCHES (2.54 MICROMETERS) MIN.,
WITH OVERALL NICKEL UNDERPLATE: 50 MICROINCHES (1.27 MICROMETERS) MIN.,
*THE PRIMARY SHIPPING CARTON WILL BE LABELED "COMPLIANT
TO RoHS DIRECTIVE 2002/95/EC AND ELV ANNEX II OF DIRECTIVE
2000/53/EC". CARTONS WITHOUT THIS LABEL MAY CONTAIN
PRODUCT WITH TIN-LEAD IN THE PC TAIL AREA.

3) PRODUCT SPECIFICATION:

CONNECTOR PERFORMANCE SPECIFICATIONS PER MOLEX
PRODUCT SPECIFICATION PS-43860-003

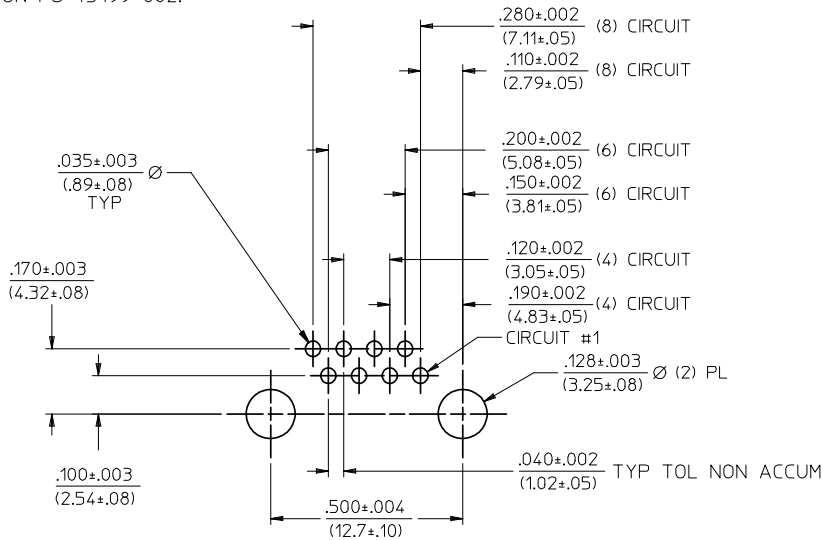
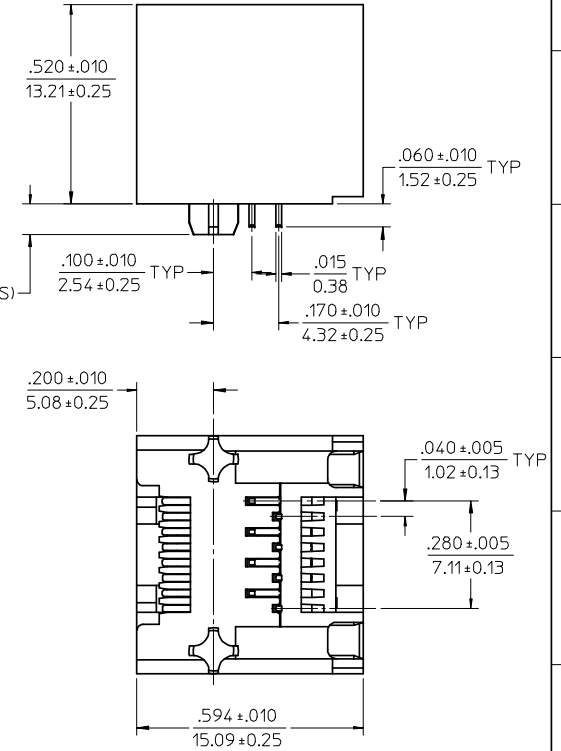
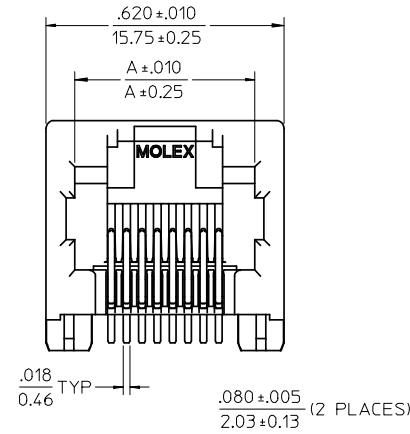
4) PACKAGING OPTIONS:

CONNECTOR ASSEMBLIES IN EXTRUDED TUBES
PER PACKAGING SPECIFICATION PK-43860-004

5) ALL UNTOLERANCED DIMENSIONS ARE SHOWN FOR REFERENCE ONLY

6) CONFORMS TO F.C.C. REGULATION PART 68.5 FOR MODULAR JACKS.

7) THIS PART CONFORMS TO CLASS B REQUIREMENTS OF COSMETIC SPECIFICATION PS-45499-002.



PC BOARD LAYOUT
COMPONENT SIDE OF BOARD
RECOMMENDED PC BOARD THICKNESS .039/1.00

MATERIAL NUMBER	CONNECTOR SIZE	DIM. "A"	CIRCUITS
44380-0001	8	.470/11.94	8
44380-0002	6	.389/9.88	6
44380-0003	6	.389/9.88	4
44380-0019	8	.470/11.94	4

RECREATED IN 3D
EC NO: UCP2008-0965
DRAWN:JBELL 2007/11/08
CHKD:LSCHMIDT 2007/12/04
APPR:FSMITH 2007/12/05

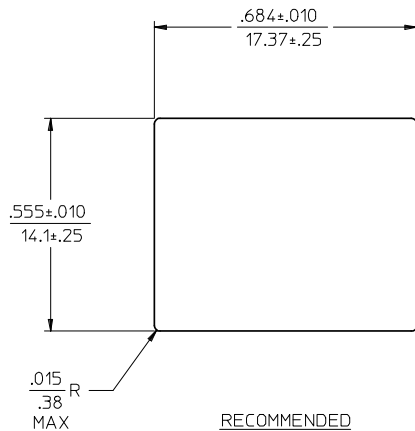
QUALITY SYMBOLS
▽=0
▽=0

GENERAL TOLERANCES (UNLESS SPECIFIED)
mm INCH
4 PLACES ± --- ± ---
3 PLACES ± --- ± ---
2 PLACES ± --- ± ---
1 PLACE ± --- ± ---
ANGULAR ±1/2°
DRAFT WHERE APPLICABLE
MUST REMAIN
WITHIN DIMENSIONS

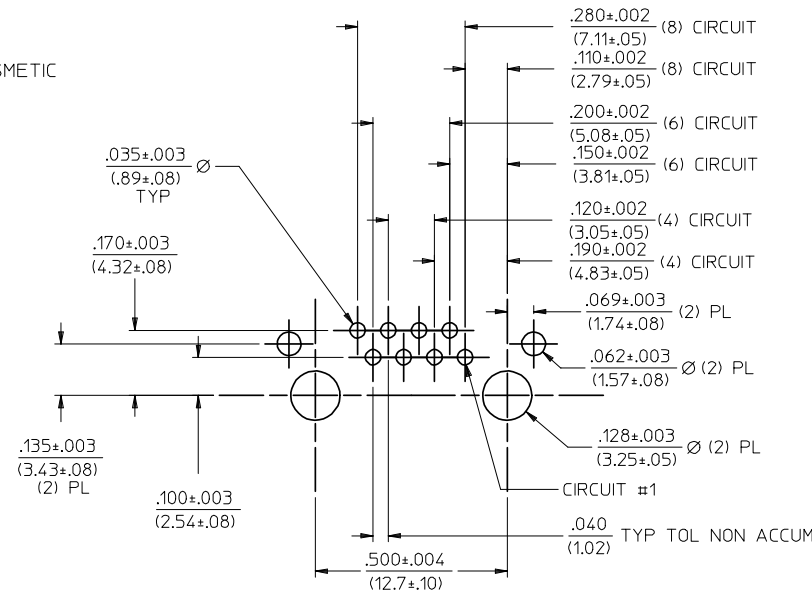
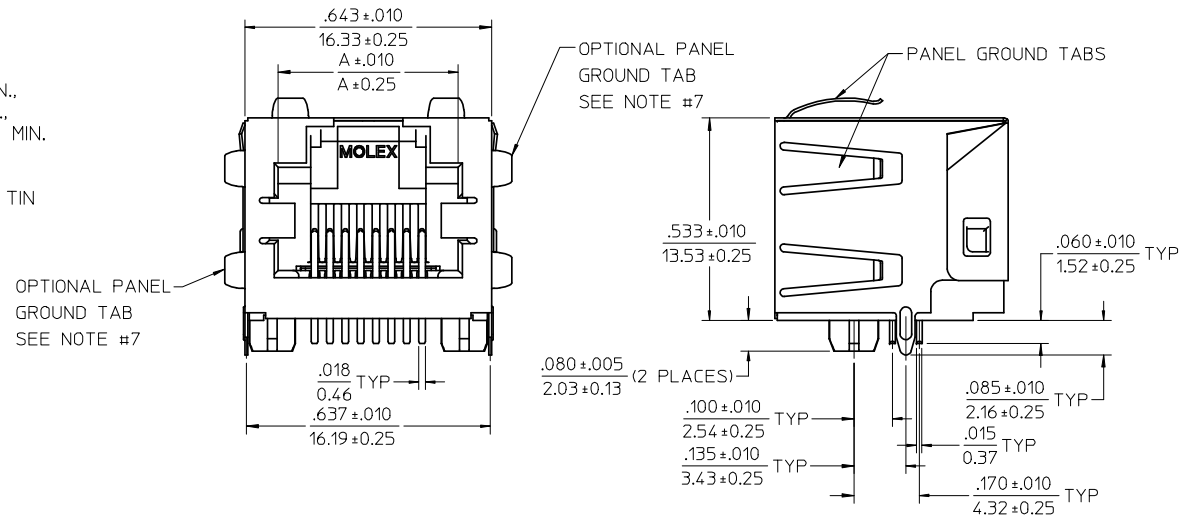
DIMENSION STYLE IN/MM
DRAWN BY DATE
MAYO 1999/04/09
CHECKED BY DATE
ROBERTS 1999/04/09
APPROVED BY DATE
ROBERTS 1999/04/09
MATERIAL NO.
SEE CHART
SIZE C

SCALE 4:1
DESIGN UNITS INCH
THIRD ANGLE PROJECTION
TITLE
INVERTED MODULAR JACK ASSEMBLY (MINI-PCI COMPLIANT)
MOLEX INCORPORATED
DOCUMENT NO. SD-44380-001
SHEET NO. 1 OF 5
THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION

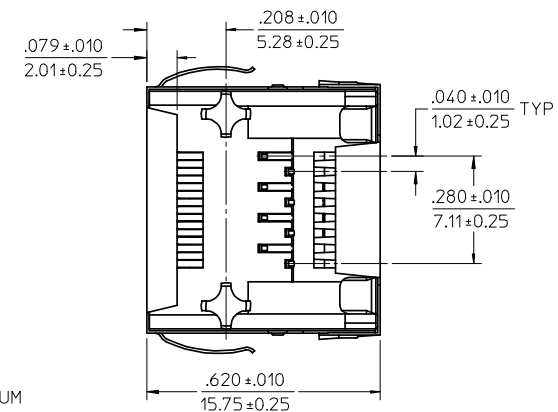
- NOTES
- 1) MATERIAL:
HOUSING: GLASS FILLED NYLON, 94V-0 COLOR: BLACK
TERMINALS: PHOSPHOR BRONZE, .015/(0.38) THICK
SHIELD: BRASS
- 2) PLATING:
TERMINALS:
SELECT GOLD IN CONTACT AREA: 50 MICROINCHES (1.27 MICROMETERS) MIN.,
*SELECT TIN IN PC TAIL AREA: 100 MICROINCHES (2.54 MICROMETERS) MIN.,
WITH OVERALL NICKEL UNDERPLATE: 50 MICROINCHES (1.27 MICROMETERS) MIN.
SHIELD:
*100 MICROINCHES (2.54 MICROMETERS) NICKEL OVER 50 MICROINCHES
(1.27 MICROMETERS) COPPER UNDERPLATE, PCB GROUND TABS DIPPED IN TIN
*THE PRIMARY SHIPPING CARTON WILL BE LABELED "COMPLIANT
TO RoHS DIRECTIVE 2002/95/EC AND ELV ANNEX II OF DIRECTIVE
2000/53/EC". CARTONS WITHOUT THIS LABEL MAY CONTAIN
PRODUCT WITH TIN-LEAD IN THE PC TAIL AREA.
- 3) PRODUCT SPECIFICATION:
CONNECTOR PERFORMANCE SPECIFICATIONS PER MOLEX
PRODUCT SPECIFICATION PS-43860-003
- 4) PACKAGING OPTIONS:
CONNECTOR ASSEMBLIES IN THERMOFORMED TRAYS
PER PACKAGING SPECIFICATION PK-44380-005
OPTION (44380-2004) PACKAGED IN TAPE AND REEL
- 5) ALL UNTOLERANCED DIMENSIONS ARE SHOWN FOR
REFERENCE ONLY
- 6) CONFORMS TO F.C.C. REGULATION PART 68.5 FOR MODULAR JACKS
- 7) AVAILABLE WITH THE (2) SPECIFIED PANEL GROUND TABS
OMITTED FOR SIDE TO SIDE STACKABILITY, PER THE
ASSEMBLY MATERIAL NUMBER TABLE.
- 8) THIS PART CONFORMS TO CLASS B REQUIREMENTS OF COSMETIC
SPECIFICATION PS-45499-002.



RECOMMENDED
PANEL
OPENING



PC BOARD LAYOUT
COMPONENT SIDE OF BOARD
RECOMMENDED PC BOARD THICKNESS: .039/1.00

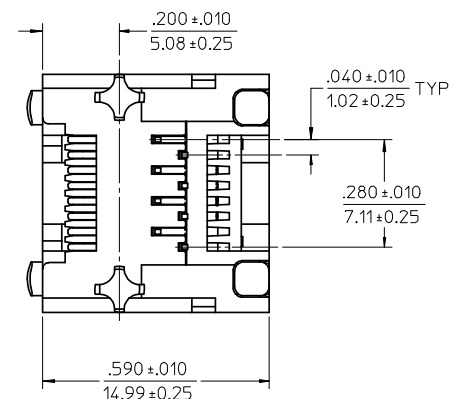
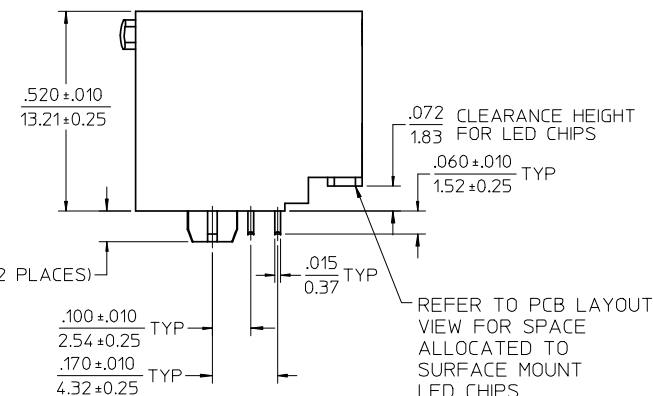
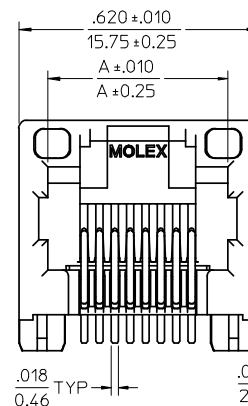


MATERIAL NUMBER	CONNECTOR SIZE	DIM. "A"	CIRCUITS	PANEL GROUND TABS
44380-0004	8	.470/11.94	8	ALL
44380-0005	6	.389/9.88	6	ALL
44380-0006	6	.389/9.88	4	ALL
44380-0013	8	.470/11.94	8	SEE NOTE #7
44380-0014	6	.389/9.88	6	SEE NOTE #7
44380-0015	6	.389/9.88	4	SEE NOTE #7
44380-2004	8	.470/11.94	8	ALL

QUALITY SYMBOLS	GENERAL TOLERANCES (UNLESS SPECIFIED)	DIMENSION STYLE	SCALE	DESIGN UNITS	THIRD ANGLE PROJECTION
▽=0 ▽=0	mm INCH 4 PLACES ± --- ± --- 3 PLACES ± --- ± --- 2 PLACES ± --- ± --- 1 PLACE ± --- ± --- ANGULAR ±1/2°	IN/MM DRAWN BY DATE MAYO 1999/04/09 CHECKED BY DATE ROBERTS 1999/04/09 APPROVED BY DATE ROBERTS 1999/04/09	4:1	INCH	
SEE SHEET 1 EC NO: UCP2008-0965 DRWN:JBELL 2007/11/08 CHKD:LSCHMIDT 2007/12/04 APPR:FSM/TH 2007/12/05	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS	MATERIAL NO. SD-44380-001	DOCUMENT NO.	SHEET NO. 2 OF 5	
		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION			

NOTES

- 1) MATERIAL:
HOUSING:
GLASS FILLED NYLON, 94V-0, COLOR: BLACK
TERMINALS:
PHOSPHOR BRONZE, .015/(0.38) THK
LIGHTPIPE:
POLYCARBONATE- WAVE OR HAND SOLDER ONLY
(NOT DESIGNED FOR I/R REFLOW OR CONVECTION REFLOW
SOLDER PROCESSES)
POLYSULFONE - MAXIMUM REFLOW TEMPERATURE: 400°F (205°C)
- 2) PLATING:
TERMINAL:
SELECT GOLD IN CONTACT AREA: 50 MICROINCHES (1.27 MICROMETERS) MIN.,
*SELECT TIN IN PC TAIL AREA: 100 MICROINCHES (2.54 MICROMETERS) MIN.,
WITH OVERALL NICKEL UNDERPLATE: 50 MICROINCHES (1.27 MICROMETERS) MIN.
*THE PRIMARY SHIPPING CARTON WILL BE LABELED "COMPLIANT
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2000/53/EC". CARTONS WITHOUT THIS LABEL MAY CONTAIN
PRODUCT WITH TIN-LEAD IN THE PC TAIL AND/OR SHIELD.
- 3) PRODUCT SPECIFICATION:
CONNECTOR PERFORMANCE SPECIFICATIONS PER MOLEX
PRODUCT SPECIFICATION PS-43860-003
- 4) PACKAGING:
PER PACKAGING SPECIFICATION PK-43860-004
- 5) APPLICATION SPECIFICATION: AS-43860-001.
- 6) ALL UNTOLERANCED DIMENSIONS ARE SHOWN FOR REFERENCE ONLY.
- 7) CONFORMS TO F.C.C. REGULATION PART 68.5 FOR MODULAR JACKS.
- 8) REFER TO PAGE (5) OF (5) FOR RECOMMENDED PCB LAYOUT.
- 9) THIS PART CONFORMS TO CLASS B REQUIREMENTS OF COSMETIC
SPECIFICATION PS-45499-002.



MATERIAL NUMBER	LIGHTPIPE MATERIAL	CONNECTOR SIZE	DIM. "A"	CIRCUITS
44380-0007	POLYCARBONATE	8	.470/11.94	8
44380-0008	POLYCARBONATE	6	.389/9.88	6
44380-0009	POLYCARBONATE	6	.389/9.88	4
44380-0020	POLYSULFONE	8	.470/11.94	8
44380-0021	POLYSULFONE	6	.389/9.88	6
44380-0022	POLYSULFONE	6	.389/9.88	4

SEE SHEET 1
EC NO: UCP2008-0965
DRWN:JBELL 2007/11/08
CHKD:LSCHMIDT 2007/12/04
APPR:FSMITH 2007/12/05

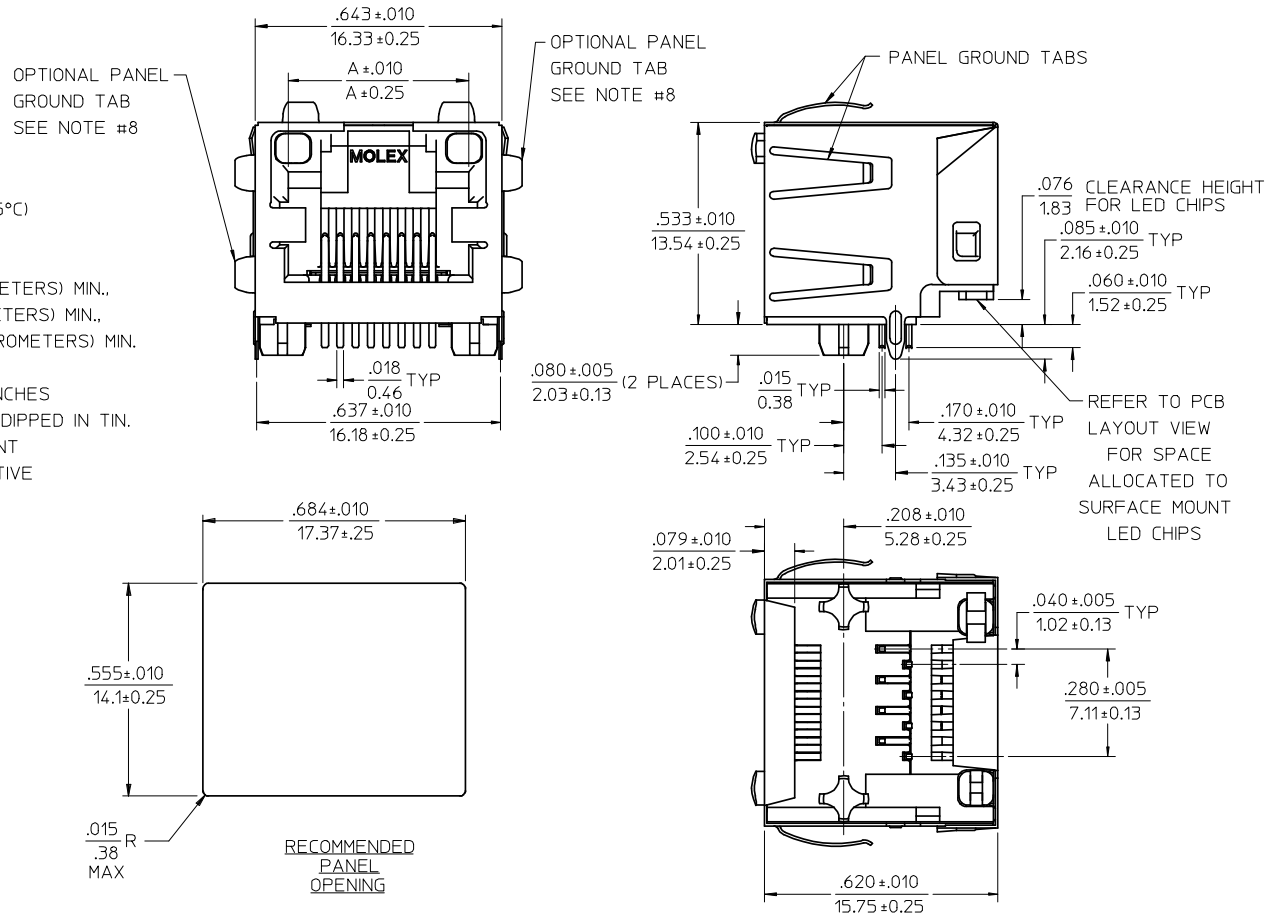
QUALITY SYMBOLS
▽=0
▽=0

GENERAL TOLERANCES (UNLESS SPECIFIED)
mm INCH
4 PLACES ± --- ± ---
3 PLACES ± --- ± ---
2 PLACES ± --- ± ---
1 PLACE ± --- ± ---
ANGULAR ±1/2°
DRAFT WHERE APPLICABLE
MUST REMAIN
WITHIN DIMENSIONS

DIMENSION STYLE IN/MM
DRAWN BY DATE
MAYO 1999/04/09
CHECKED BY DATE
ROBERTS 1999/04/09
APPROVED BY DATE
ROBERTS 1999/04/09
MATERIAL NO.
SEE CHART
SIZE C

SCALE 4:1
DESIGN UNITS INCH
THIRD ANGLE PROJECTION
INVERTED MODULAR JACK ASSEMBLY (MINI-PCI COMPLIANT)
MOLEX INCORPORATED
DOCUMENT NO. SD-44380-001
SHEET NO. 3 OF 5
THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION

- NOTES
- 1) MATERIAL:
- HOUSING:
- GLASS FILLED NYLON, 94V-0, COLOR: BLACK
- TERMINALS:
- PHOSPHOR BRONZE, .015/(0.38) THK
- SHIELD:
- BRASS
- LIGHTPIPE:
- POLYCARBONATE - WAVE OR HAND SOLDER ONLY
(NOT DESIGNED FOR I/R REFLOW OR CONVECTION REFLOW
SOLDER PROCESSES)
- POLYSULFONE - MAXIMUM REFLOW TEMPERATURE: 400°F (205°C)
- 2) PLATING:
- TERMINAL:
- SELECT GOLD IN CONTACT AREA: 50 MICROINCHES (1.27 MICROMETERS) MIN.,
*SELECT TIN IN PC TAIL AREA: 100 MICROINCHES (2.54 MICROMETERS) MIN.,
WITH OVERALL NICKEL UNDERPLATE: 50 MICROINCHES (1.27 MICROMETERS) MIN.
- SHIELD:
- *100 MICROINCHES (2.54 MICROMETERS) NICKEL OVER 50 MICROINCHES
(1.27 MICROMETERS) COPPER UNDERPLATE, PCB GROUND TABS DIPPED IN TIN.
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TO RoHS DIRECTIVE 2002/95/EC AND ELV ANNEX II OF DIRECTIVE
2002/53/EC". CARTONS WITHOUT THIS LABEL MAY CONTAIN
PRODUCT WITH TIN-LEAD IN THE PC TAIL AND/OR SHIELD.
- 3) PRODUCT SPECIFICATION:
- CONNECTOR PERFORMANCE SPECIFICATIONS PER MOLEX
PRODUCT SPECIFICATION PS-43860-003.
- 4) PACKAGING:
- CONNECTOR ASSEMBLIES IN THERMOFORMED TRAYS
PER PACKAGING SPECIFICATION PK-44380-005 .
- 5) APPLICATION SPECIFICATION: AS-43860-001.
- 6) ALL UNTOLERANCED DIMENSIONS ARE SHOWN FOR
REFERENCE ONLY.
- 7) CONFORMS TO F.C.C. REGULATION PART 68.5
FOR MODULAR JACKS.
- 8) AVAILABLE WITH THE (2) SPECIFIED PANEL GROUND TABS
OMITTED FOR SIDE TO SIDE STACKABILITY, PER THE
ASSEMBLY MATERIAL NUMBER TABLE.
- 9) REFER TO SHEET (5) OF (5) FOR RECOMMENDED PCB LAYOUT.
- 10) THIS PART CONFORMS TO CLASS B REQUIREMENTS OF COSMETIC
SPECIFICATION PS-45499-002.



MATERIAL NUMBER	LIGHTPIPE MATERIAL	CONN SIZE	DIM. "A"	CIRCUITS	PANEL GROUND TABS
44380-0010	POLYCARBONATE	8	.470/11.94	8	ALL
44380-0011	POLYCARBONATE	6	.389/9.88	6	ALL
44380-0012	POLYCARBONATE	6	.389/9.88	4	ALL
44380-0016	POLYCARBONATE	8	.470/11.94	8	SEE NOTE #8
44380-0017	POLYCARBONATE	6	.389/9.88	6	SEE NOTE #8
44380-0018	POLYCARBONATE	6	.389/9.88	4	SEE NOTE #8
44380-1010	POLYSULFONE	8	.470/11.94	8	ALL
44380-1011	POLYSULFONE	6	.389/9.88	6	ALL
44380-1012	POLYSULFONE	6	.389/9.88	4	ALL
44380-1016	POLYSULFONE	8	.470/11.94	8	SEE NOTE #8
44380-1017	POLYSULFONE	6	.389/9.88	6	SEE NOTE #8
44380-1018	POLYSULFONE	6	.389/9.88	4	SEE NOTE #8

SEE SHEET 1

EC NO: WCP2008-0965

DRWN:JBELL 2007/11/08

CHKD:LSCHMIDT 2007/12/04

APPR:FSM/TH 2007/12/05

REV

QUALITY SYMBOLS

▽=0

▽=0

GENERAL TOLERANCES (UNLESS SPECIFIED)

	mm	INCH
4 PLACES ±	---	---
3 PLACES ±	---	---
2 PLACES ±	---	---
1 PLACE ±	---	---

ANGULAR ±1/2°

DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS

DIMENSION STYLE

IN/MM

DRAWN BY MAYO 1999/04/09

CHECKED BY ROBERTS 1999/04/09

APPROVED BY ROBERTS 1999/04/09

MATERIAL NO.

SEE CHART

SIZE

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SCALE 4:1

DESIGN UNITS INCH

THIRD ANGLE PROJECTION

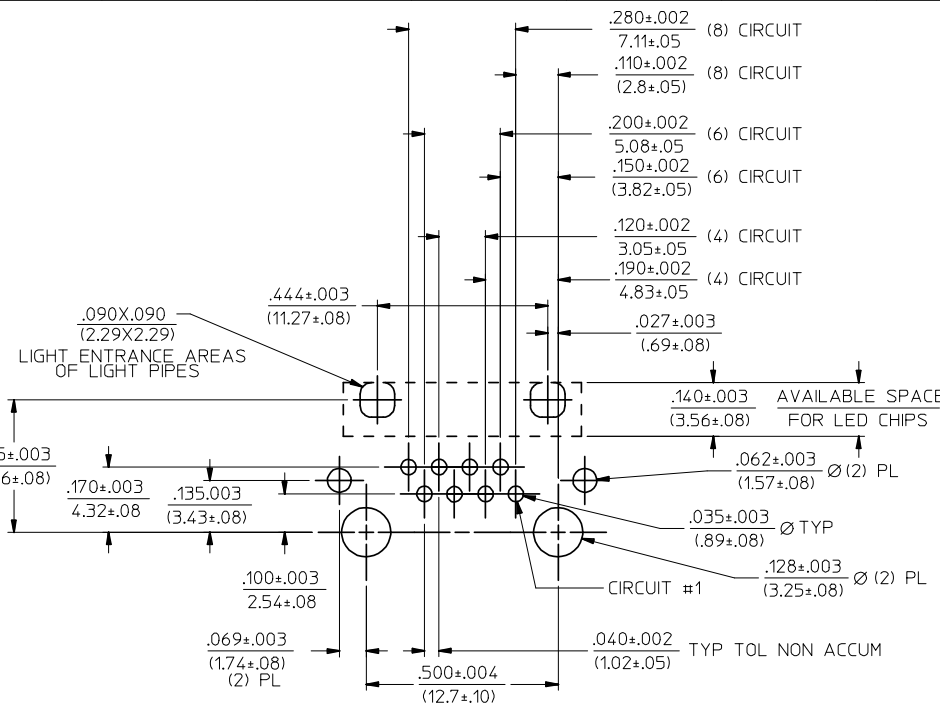
INVERTED MODULAR JACK ASSEMBLY (MINI-PCI COMPLIANT)

MOLEX INCORPORATED

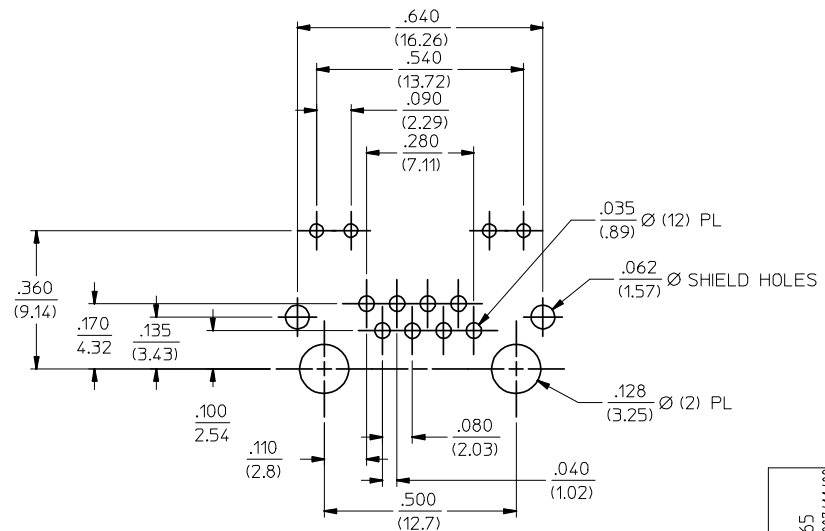
DOCUMENT NO. SD-44380-001

SHEET NO. 4 OF 5

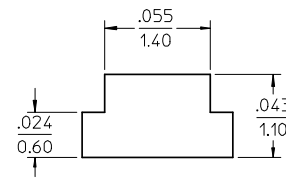
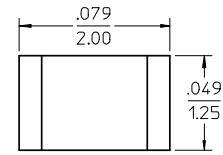
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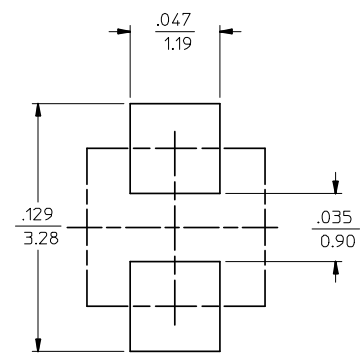
MOLEX RECOMMENDED
PC BOARD LAYOUT
COMPONENT SIDE OF BOARD
RECOMMENDED PC BOARD THICKNESS: .039/1.00



TYPICAL COMPETITION
PCB LAYOUT WITH
INTEGRAL LED'S
(SHOWN FOR REFERENCE ONLY)
RECOMMENDED PC BOARD THICKNESS: .039/1.00



RECOMMENDED SMT
LED DIMENSIONS
SCALE 20:1
(SEE NOTE 1)



RECOMMENDED SMT
LED SOLDER PATTERN
SCALE 20:1
(SEE NOTE 1)

NOTES:
1. FOR CROSS REFERENCE OF RECOMMENDED LEDS SEE MOLEX WEB SITE.

SEE SHEET 1 EC NO: UCP2008-0965 DRWN:JBELL 2007/11/08 CHKD:LSCHMIDT 2007/12/04 APPR:FSMITH 2007/12/05	DESCRIPTION	QUALITY SYMBOLS ▽=0 ▽=0	GENERAL TOLERANCES (UNLESS SPECIFIED)	DIMENSION STYLE		SCALE	DESIGN UNITS	THIRD ANGLE PROJECTION				
				IN/MM		4:1	INCH					
					mm	INCH	DRAWN BY	DATE	TITLE INVERTED MODULAR JACK ASSEMBLY (MINI-PCI COMPLIANT)			
				4 PLACES	± ---	± ---	MAYO	1999/04/09				
				3 PLACES	± ---	± ---	CHECKED BY	DATE				
				2 PLACES	± ---	± ---	ROBERTS	1999/04/09				
				1 PLACE	± ---	± ---	APPROVED BY	DATE	MOLEX INCORPORATED			
				ANGULAR ±1/2°			ROBERTS	1999/04/09				
				DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS			MATERIAL NO.		DOCUMENT NO.		SHEET NO.	
							SEE CHART		SD-44380-001		5 OF 5	
SIZE	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION											